

### **AMENDMENTS TO THE SPECIFICATION**

Please change the title as follows:

AI/AIN JOINT MATERIAL, BASE PLATE FOR POWER MODULE, POWER MODULE,  
AND MANUFACTURING METHOD OF AI/AIN JOINT MATERIAL

Please remove the sentence starting from line 11 under TECHNICAL FIELD on page 1 and  
add the paragraph as follows:

~~Priority is claimed on Japanese patent Application No. 2004-110879, filed April 5, 2004,  
and Japanese Patent Application No. 2004-221700, filed July 29, 2004, the contents of which are  
incorporated herein by reference.~~

### **CROSS-REFERENCE TO PRIOR APPLICATION**

This is a U.S. National Phase Application under 35 U.S.C. §371 of International Patent  
Application No. PCT/JP2005/006618 filed April 4, 2005, and claims the benefit of Japanese Patent  
Applications No. 2004-110879, filed April 5, 2004 and 2004-221700, filed July 29, 2004, all of  
which are incorporated by reference herein. The International Application was published in  
Japanese on October 20, 2005 as WO 2005/098942 A1 under PCT Article 21(2).